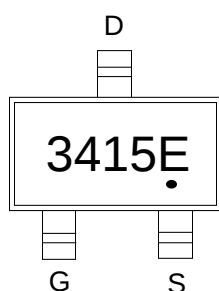


Features

- Leading trench technology for low $R_{DS(on)}$
- Low Gate Charge

Application

- Video monitor
- Power management

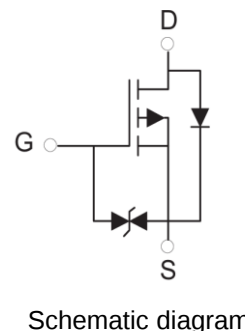
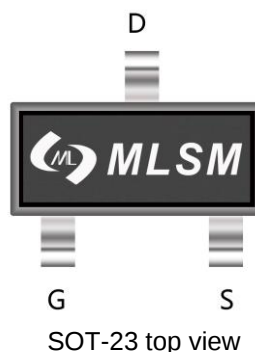


3415E: Device code

Marking and pin assignment

Product Summary

V_{DS}	$R_{DS(on)}$ MAX	I_D MAX
-20V	45mΩ@-4.5V	-5A
	65mΩ@-2.5V	



Halogen-Free

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
--------	-----------	--------	------

Common Ratings (TC=25°C Unless Otherwise Noted)

V_{DS}	Drain-Source Breakdown Voltage	-20	V
V_{GS}	Gate-Source Voltage	±10	V
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
I_S	Diode Continuous Forward Current	$T_C=25^\circ\text{C}$ -5	A

Mounted on Large Heat Sink

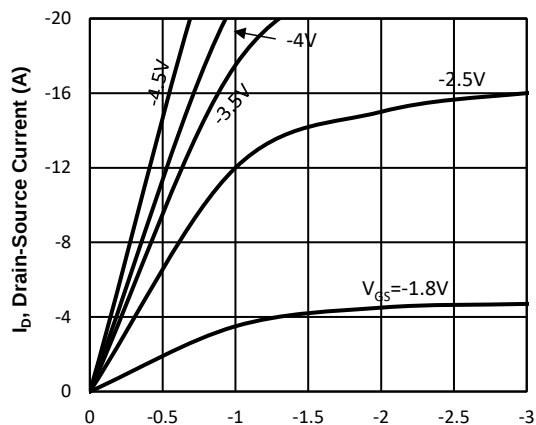
I_{DM}	Pulse Drain Current Tested	$T_C=25^\circ\text{C}$ -30	A
I_D	Continuous Drain Current	$T_C=25^\circ\text{C}$ -5	A
P_D	Maximum Power Dissipation	$T_C=25^\circ\text{C}$ 1.5	W
$R_{\theta JA}$	Thermal Resistance Junction-to-Ambient	100	°C/W

Ordering Information (Example)

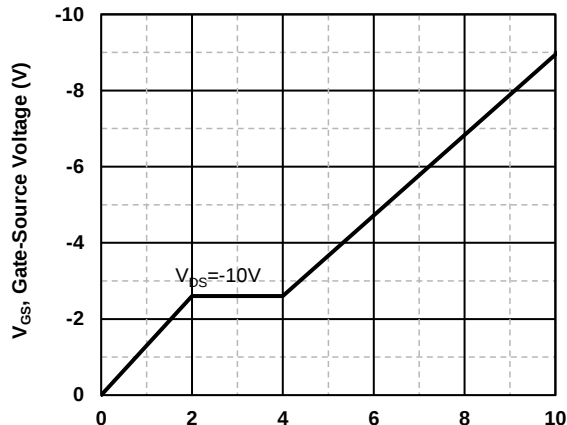
Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MLS3415E	SOT-23	3415E	3,000	45,000	180,000	7"reel

Electrical Characteristics (TJ=25℃ unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ TJ = 25℃ (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-20	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-20V, V _{GS} =0V	--	--	-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±10V, V _{DS} =0V	--	--	±10	μA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-0.4	-0.85	-1.0	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-4.5V, I _D =-4A	--	28	45	mΩ
		V _{GS} =-2.5V, I _D =-3A	--	45	65	mΩ
		V _{GS} =-1.8V, I _D =-1A	--	95	150	mΩ
Dynamic Electrical Characteristics @ TJ = 25℃ (unless otherwise stated)						
C _{ISS}	Input Capacitance	V _{DS} =-10V, V _{GS} =0V, f=1MHz	--	540	--	pF
C _{OSS}	Output Capacitance		--	120	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	100	--	pF
Switching Characteristics						
Q _g	Total Gate Charge	V _{DS} =-10V, I _D =-5A, V _{GS} =-4.5V	--	13	--	nC
Q _{gs}	Gate Source Charge		--	2	--	nC
Q _{gd}	Gate Drain Charge		--	2	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DD} =-10V, I _D =-5A, V _{GS} =-10V, R _G =2.2Ω	--	5	--	nS
t _r	Turn-on Rise Time		--	47	--	nS
t _{d(off)}	Turn-Off Delay Time		--	52	--	nS
t _f	Turn-Off Fall Time		--	68	--	nS
Source- Drain Diode Characteristics						
V _{SD}	Forward on voltage	Tj=25℃, Is=-5A	--	--	-1.2	V

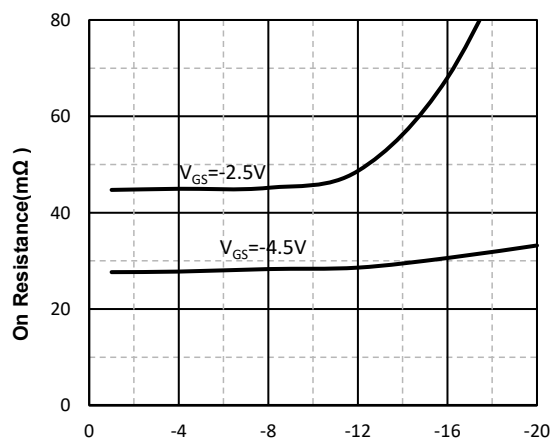
Typical Operating Characteristics



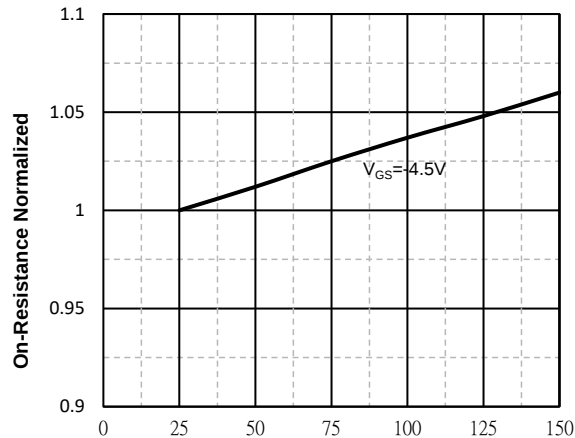
V_{DS} , Drain -Source Voltage (V)
Fig1. Typical Output Characteristics



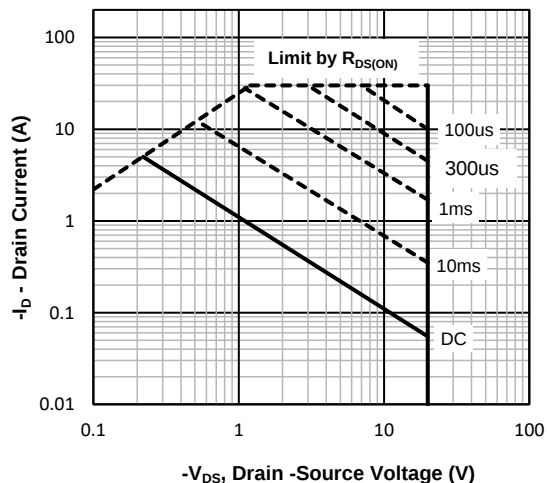
Q_g -Total Gate Charge (nC)
Fig2. Typical Gate Charge Vs. Gate-Source Voltage



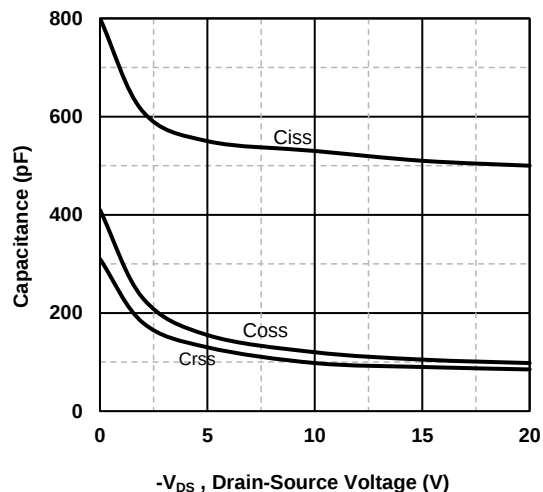
I_D , Drain-Source Current (A)
Fig3. Drain-Source on Resistance



T_j - Junction Temperature (°C)
Fig4. Normalized On-Resistance Vs. Temperature

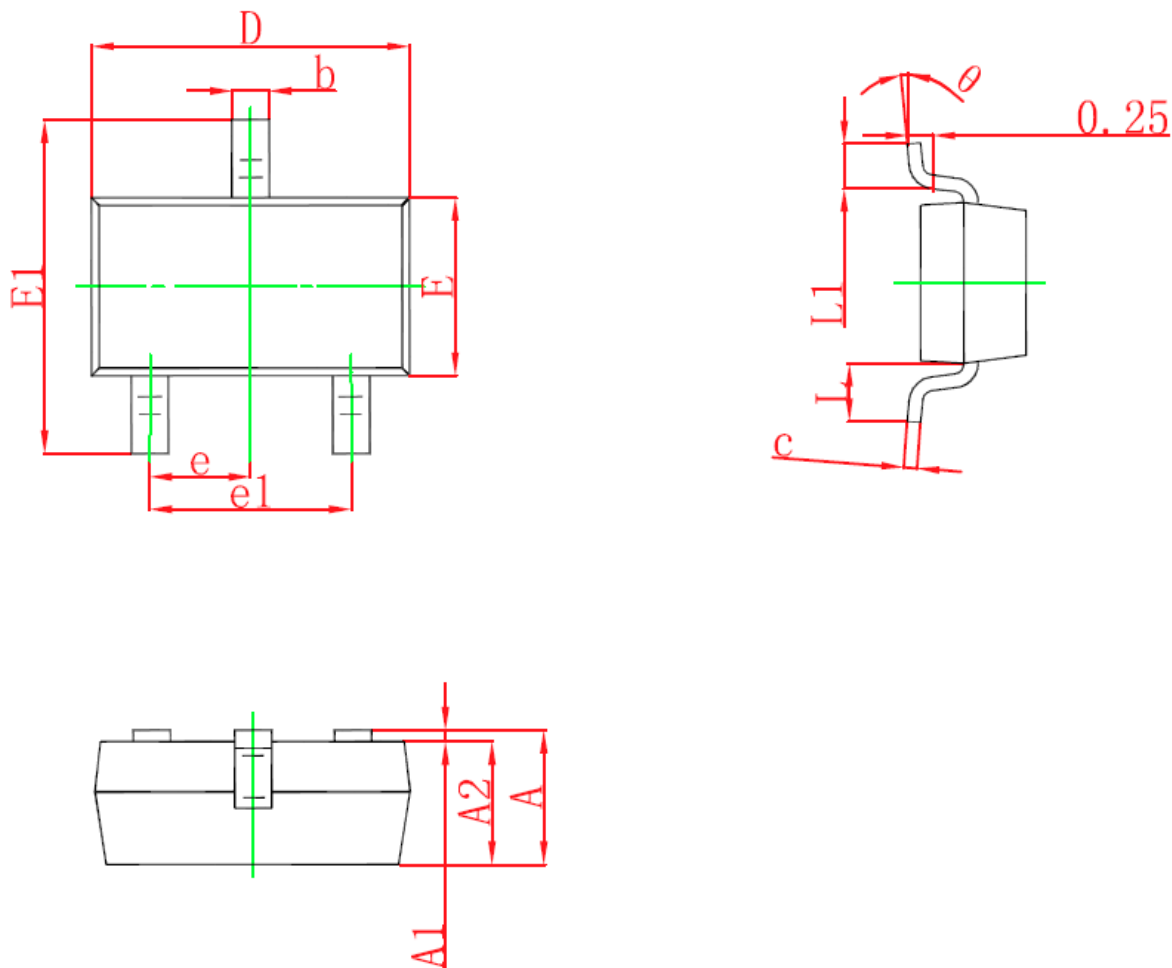


V_{DS} , Drain -Source Voltage (V)
Fig5. Maximum Safe Operating Area



V_{DS} , Drain-Source Voltage (V)
Fig6 Typical Capacitance Vs. Drain-Source Voltage

SOT-23 Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.550REF		0.022REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°